Overview

HP ProBook 635 Aero G7 Notebook PC



- Ambient Light Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Camera Shutter (Only available with webcam)
- 5. HD and IR Camera (Optional)

- 7. Glass Clickpad
- 8. Audio Combo Jack
- 9. USB 3.1 Gen 1 Port
- 10. USB 3.1 Gen 1 Charging Port

IR Camera LED (Optional)

11 Nano Security Lock Slot (Lock sold separately)

Overview



- 1. Power Button Key
- 2. Power Connector
- 3. HDMI Port (Cable not included)
- 4. USB Type-C[®] 3.1 Gen 2 Port (Alt Mode)
- 5. Nano SIM Card Slot1
- 6. Touch Fingerprint Sensor (select models)

1. All units have a SIM card stray but units that do not support WWAN are shipped with a non-removable SIM slot plug

Overview

At a Glance

- An ultralight laptop all-metal design with recycled aluminum and magnesium alloys, that breaks the 1kg barrier (250 nit panel, HP Sure View Reflect, multiple SODIMMs, WWAN, 53Whr battery, and backlit keyboard not available on configurations starting at less than 1kg)
- Choice of AMD Ryzen™ 4000 Series Mobile Processors
- Preinstalled with Windows 10 versions or FreeDOS
- Choice of 33.8 cm (13.3") diagonal ultra wide viewing angle FHD and privacy panel option
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi 6 and CAT9 4G/LTE WWAN
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32GB
- Choice of solid state drives up to 1TB
- Features quiet and responsive HP Premium Keyboard with the HP Programmable key and backlit options
- Multi-layered security with HP SureStart Gen6, HP Privacy Camera, HP Sure View Reflect¹, HP Sure Recover, HP Sure Run, HP Sure Sense, HP Sure Click, and Touch Fingerprint sensor²
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles³
- Designed to support HP docking options including the HP Universal Dock G5
- Passed MIL-STD 810H tests ⁴
- Battery life up to 23 hours (AMD Ryzen™ 4000 Series Mobile Processors and 3-cell 53 WHr battery)
- Enables AMD Memory Guard to help defend against cold boot attacks with real-time encryption and decryption of system's memory with AMD Ryzen PRO Processors
- 1. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 2. Sold seperately or as an optional feature
- 3. HP notebooks up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance."
- 4. MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP ProBook 635 Aero G7 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64 – HP recommends Windows 10 Pro 1

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)¹

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

 Note: HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282.

Supported Versions

HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282

PROCESSORS

AMD Ryzen™ 3 4300U APU with Radeon™ Graphics (2.7 GHz base clock, up to 3.7 GHz max boost clock, 4 MB L3 cache, 4 cores) ^{3,4,5}

AMD Ryzen[™] 5 4500U APU with Radeon[™] Graphics (2.3 GHz base clock, up to 4.0 GHz max boost clock, 8 MB L3 cache, 6 cores) ^{3,4,5}

AMD Ryzen[™] 7 4700U APU with Radeon[™] Graphics (2.0 GHz base clock, up to 4.1 GHz max boost clock, 8 MB L3 cache, 8 cores) ^{3,4,5}

AMD Ryzen™ 5 PRO 4650U APU with Radeon™ Graphics (2.1 GHz base clock, up to 4 GHz max boost clock, 8 MB L3 cache, 6 cores) ^{3,4,5}

AMD Ryzen[™] 7 PRO 4750U APU with Radeon[™] Graphics (1.7 GHz base clock, up to 4.1 GHz max boost clock, 8 MB L3 cache, 8 cores) ^{3,4,5}

Processors Family

AMD Ryzen[™] 4000 Series Mobile Processors⁴⁰

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.
 40. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



Technical Specifications

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics6

Supports

Support HD decode, DX12, HDMI2.0

6. HD content required to view HD images.

DISPLAYS

Internal

Non-Touch

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC (1920 x 1080) ^{6,7,8} 33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD camera (1920 x 1080) ^{6,7,8}

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080) 6,7,8

33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power bent with Ambient Light Sensor, 400 nits, 100%sRGB for HD + IR camera (1920 x 1080) 8,11

33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power bent with Ambient Light Sensor, 400 nits, 100%sRGB for HD + IR camera for WWAN (1920 x 1080) 8,11

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Reflect Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera (1920 x 1080) 6,7,8,9

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Reflect Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera for WWAN (1920 x 1080) ^{6,7,8,9}

HDMI

Support resolution up to 4k @ 60Hz

- 6. HD content required to view HD images.
- 7. Sold separately or as an optional feature.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 9. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

NOTE: Actual brightness will be lower with touchscreen or Sure View.



Technical Specifications

STORAGE AND DRIVES

Primary M.2 Storage

128 GB M.2 SATA-3 TLC Solid State Drive ¹⁰
256 GB PCIe® Gen3x4 NVMe™ TLC Solid State Drive ¹⁰
256 GB PCIe® NVMe™ Value Solid State Drive ¹⁰
512 GB PCIe® Gen3x4 NVMe™ TLC Solid State Drive ¹⁰
512 GB PCIe® NVMe™ Value Solid State Drive ¹⁰
1 TB PCIe® Gen3 x4 NVMe™ TLC Solid State Drive ¹⁰

10. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB DDR4-3200 SDRAM

Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹¹
16 GB DDR4-3200 SDRAM (1 x 16 GB)
16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹¹
8 GB DDR4-3200 SDRAM (1 x 8 GB)
8 GB DDR4-3200 SDRAM (2 x 4 GB)
4 GB DDR4-3200 SDRAM (1 x 4 GB)

Memory Slots

2 SODIMM Both slots are accessible/upgradeable by IT or self-maintainers only DDR4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

11. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



Technical Specifications

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, non-vPro® 12 Realtek RTL8822CE 802.11ac (2x2) and Bluetooth® 5 Combo⁴³

WWAN

Intel® XMM™ 7360 LTE-Advanced Cat 9 14

- 12. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.
- 43. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
- 14. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

AUDIO/MULTIMEDIA

Audio

Integrated microphone (Dual Array)
2 Integrated Stereo Speakers

Speaker Power

2W/4ohm Per speaker

Camera

720p HD camera ^{6,7} 720p HD+IR camera ^{6,7,15}

Sensors

Ambient light sensor (select models only) Hall Sensor

- 6. HD content required to view HD images.
- 7. Sold separately or as an optional feature.
- 15. Internet access required.



Technical Specifications

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant, Durakeys Optional backlit keyboard

Pointing Device

Clickpad with multi-touch gestures enabled, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

F1 - Display Switching

F2 - Blank or Privacy (with LED)

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Programmable Key

Print Screen

Power Button (with LED)

Hiden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

Fn+E - Insert

Fn+W - Pause

Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

HP BIOSphere Gen5 ¹⁶
HP Drive Lock & Automatic Drive Lock
BIOS Update via Network
Master Boot Record Security
Power On Authentication
HP Secure Erase ¹⁸
Absolute Persistence Module ¹⁹
HP LAN-Wireless Protection

Software

HP Connection Optimizer 17

Pre-boot Authentication

HP Image Assistant

HP Hotkey Support

myHP

HP Support Assistant 20

HP Noise Cancellation Software

HSA Fusion for Commercial



Technical Specifications

HSA Telemetry for Commercial Touchpoint Customizer for Commercial HP Notifications HP Privacy Settings HP Wireless Button Driver HP Power Manager HP WorkWell

Manageability Features

Buy Office (sold separately)

HP Driver Packs (download) ²¹
HP Manageability Integration Kit Gen3 (download) ²²
HP System Software Manager (SSM) (download)
HP BIOS Config Utility (BCU) (download)
HP Client Catalog (download)
HP Client Management Script Library (download)

Client Security Software

HP Client Security Manager Gen6 ²³ Windows Defender ²⁴

Security Management

Pre-boot Authentication
USB enable/disable (via BIOS)
Power-on password (via BIOS)
Setup password (via BIOS)
HP Fingerprint Sensor ²⁵
Support for chassis padlocks and cable lock devices
HP Pro Security Edition
HP Sure Click ²⁶
HP Sure Sense ²⁷
HP Sure Start Gen6 ²⁸
HP Sure Admin ²⁹
HP Sure Recover Gen3 ³⁰
HP Sure Run Gen3 ³¹

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)(FIPS 140-2 Level 2 Certified) 32

16. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

17. HP Connection Optimizer requires Windows 10.

18. HP Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

19. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/20. HP Support Assistant requires Windows and Internet access.

21. HP Driver Packs not preinstalled, however available for download at

http://www.hp.com/go/clientmanagement.

- 22. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 23. HP Client Security Manager Gen6 requires Windows and is available on the select HP Pro and Elite PCs.
- 24. Windows Defender Opt in and internet connection required for updates.
- 25. HP Fingerprint sensor is an optional feature that must be configured at purchase.



Technical Specifications

26. HP Sure Click requires Windows 10 Pro or Enterprise and supports Microsoft® Internet Explorer, Google Chrome, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

27. HP Sure Sense requires Windows 10 Pro or Enterprise.

28. HP Sure Start Gen6 is available on select HP PCs.

29. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

30. HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.

31. HP Sure Run Gen3 is available on select Windows 10 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors.

32. Firmware TPM is version 2.0.



Technical Specifications

POWER

Power Supply

HP Smart 45 W External AC power adapter ³³
HP Smart 45 W External AC power adapter, 2-prong (Japan only) ³³
HP Smart 45 W USB Type-C[®] adapter ³³
HP Smart 65 W External AC power adapter ³³
HP Smart 65 W EM External AC power adapter ³³
Hp Smart 65 W USB Type-C[®] adapter ³³

Primary Battery

HP Long Life 3-cell, 42 Wh Li-ion ^{34,35} HP Long Life 3-cell, 53 Wh Li-ion ^{34,35} Support HP Fast Charge (Up to 50% in 30 minutes with 65W AC Adapter) ^{34,35}

Power Cord

3-wire plug – 1.0m ³³ 2-wire plug – 1.0m ³³

Battery life

MM14 Battery life³⁶ 42Whr battery: Up to 18 hours 53Whr battery: Up to 23 hours

MM18 Battery life³⁶
42Whr battery: Up to 11 hours
53Whr battery: Up to 15 hours³⁶

Battery Weight

42W battery: 0.168 kg (0.37 lb) 53W battery: 0.205g (0.45 lb)

- 33. Availability may vary by country.
- 34. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 35. Supports HP Fast Charge with 65W AC Adapter. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 36. Windows 10 MM18 battery life and Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.



Technical Specifications

WEIGHTS & DIMENSIONS

Product Weight

Starting at 2.2 lb ³⁷ Starting at 0.99 kg ³⁷

Product Dimensions (w x d x h)

400 nits and 1000 nits panels: 12.11 x 8.05x 0.71in 30.76 x 20.45 x 1.79 cm

250 nits panels: 12.11 x 8.05x 0.76in 30.76 x 20.45 x 1.92 cm

37. Weight will vary by configuration.

PORTS/SLOTS

Ports

1 USB 3.1 Type-C[®] Gen2 (Power delivery, DisplayPort[™] 1.4)

2 USB 3.1 Gen 1 (1 charging port)

1 HDMI 2.0 38

1 Headphone/microphone combo

1 AC power

1 Nano SIM card slot 39

38. HDMI cable sold separately.

39. SIM slot is not user accessible without WWAN configuration.

SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life Batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 40

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

ENERGY STAR® certified EPEAT® Gold in the U.S.⁴¹ Low halogen⁴²



Technical Specifications

TCO Certified

- 41. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.
- 42. External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19 V
Average Operating Power 2.82W
Integrated graphics 6.78W
Discrete Graphics N/A

Max Operating Power UMA < 45W

Temperature

Operating 41° to 95° F (5° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 0.75 grms
Non-operating 1.50 grms

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard Certifications

UL Yes
CSA Yes
FCC Compliance Yes

ENERGY STAR® Select models 42

EPEAT® 2019 Gold in U.S.⁴¹

ICES Yes Australia / Yes NZ A – Tick Compliance Yes CCCYes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marketing Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes Yes

42. Configurations of the HP ProBook 635 Aero G7 that are ENERGY STAR® qualified are identified as P ProBook 635 Aero G7 ENERGY STAR on HP websites and on http://www.energystar.gov.

41. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information.



Technical Specifications

DISPLAYS

NOTE: All specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower. Actual brightness will be lower with touchscreen or Sure View.

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent NWBZ Outline Dimensions (W x H x D) 300.56 x 177.77 mm (max) (FPC folding included)

Active Area 293.76 x 165.24 mm (typ.)

Weight 260 g (max)
Diagonal Size 13.3 inch

Thickness 3.0 mm/ 5.0 mm (PCB) (max)

InterfaceeDP 1.2 (2lane)Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio600:1 (typ.)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED
Color Gamut Coverage NTSC 45%
Color Depth 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NB2Y Outline Dimensions (W x H x D) 299.06 x 176.54 mm (max) (FPC folding included)

Active Area 293.76 x 165.24 mm (typ.)

Weight 175 g (max)
Diagonal Size 13.3 inch

Thickness 2.0 mm / 3.8 mm (PCB) (max) **Interface** eDP 1.4 w/ PSRII (2 lane)

Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio1500:1(typ.)Refresh Rate60 HzBrightness400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED

Color Gamut Coverage sRGB 100% **Color Depth** 8 bits

Viewing Angle UWVA 85/85/85

Technical Specifications

Panel LCD 13.3inch FHD (1920x1080) Anti-Glare WLED UWVA 72percent cg 1000nits eDP 1.4+PSR PrivacyG4

 Outline Dimensions (W x H x D)
 299.06 x 176.54 mm (max)

 Active Area
 293.76 x 165.24 mm (typ.)

Weight220 g (max)Diagonal Size13.3 inchThickness3.9 mm (max)

Interface eDP 1.4 + PSR (4 lane)

Surface Treatment Anti-glare (AG)

Touch Enabled No

Contrast Ratio 1500:1 (typ.)

Refresh Rate 60 Hz **Brightness** 1000 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB
Backlight LED
Color Gamut Coverage NTSC 72%
Color Depth 8 bits

Viewing Angle UWVA 85/85/85



Technical Specifications

STORAGE AND DRIVES*

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 M2 SATA-3 Form Factor M.2 2280 TLC

Capacity

NAND Type

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Weight 0.02 lb (10 g) Interface **ATA-8, SATA 3.0 Maximum Sequential Read** 550 ~ 560 MB/s **Maximum Sequential Write** 380 ~ 530 MB/s **Logical Blocks** 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

128 GB TLC

Features ATA Security: DIPM; TRIM; DEVSLP

SSD 1TB 2280 PCIe-3x4 **NVMe Three Layer Cell** single-sided

Form Factor M.2 2280 Capacity 1 TB **NAND Type** TLC

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Weight 0.02 lb (10 g) Interface PCIe NVMe Gen3X4 **Maximum Sequential Read** 3100 ~ 3500 MB/s **Maximum Sequential Write** 2770 ~ 3037 MB/s **Logical Blocks** 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2



Technical Specifications

SSD 256GB 2280 PCIe NVMe Form Factor

Value

Form Factor M.2 2280
Capacity 256 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3

 Maximum Sequential Read
 2100 ~ 2200 MB/s

 Maximum Sequential Write
 900 ~ 1400 MB/s

 Logical Blocks
 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security (optional); TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Form Factor

Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3

 Maximum Sequential Read
 2200 ~ 2300 MB/s

 Maximum Sequential Write
 1000 ~ 1600 MB/s

 Logical Blocks
 1.000.215.215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security (optional); TRIM; L1.2

SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X4Maximum Sequential Read2800 ~ 3500 MB/sMaximum Sequential Write1400 ~ 2200 MB/sLogical Blocks500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2

Technical Specifications

SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 3100 ~ 3500 MB/s

 Maximum Sequential Write
 2400 ~ 2956 MB/s

 Logical Blocks
 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2

NETWORKING / COMMUNICATIONS

Intel® Wi-Fi 6¹ AX200 + Bluetooth® 5 (802.11ax 2x2, non-vPro®, supporting gigabit file transfer speeds) non-vPro®² Wireless LAN Standards IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11h
IEEE 802.11i

Interoperability Features Wi-Fi 6 technology

Frequency Band

802.11b/g/n/ax

•2.402 – 2.482 GHz

802.11a/n/ac/ax

•4.9 – 4.95 GHz (Japan)

•5.15 – 5.25 GHz

•5.25 – 5.35 GHz

•5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz

IEEE 802.11k IEEE 802.11r IEEE 802.11v

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

•802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware



Technical Specifications

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

 WPA2 certification •IEEE 802.11i

•WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points Output Power² • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum 802.11ac VHT80(5GHz): +11.5dBm minimum 802.11ac VHT160(5GHz): +11.5dBm minimum 802.11ax HT40(2.4GHz): +10dBm minimum

802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption

 Transmit mode: 2.0 W Receive mode: 1.6 W

 Idle mode (PSP) 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby: 10mW

• Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management 802.11 compliant

power saving mode

Receiver Sensitivity³

• 802.11b. 1Mbps: -93.5dBm maximum • 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/q, 54Mbps: -72dBm maximum 802.11n. MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum • 802.11ac, MCS0: -84dBm maximum • 802.11ac, MCS9: -59dBm maximum • 802.11ax, MCS11(HT40): -59dBm maximum • 802.11ax, MCS11(VHT160): -58.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm

1. Type 2230: 2.8 g Weight 2. Type 126: 1.3 q

3.3v +/- 9%

Operating Voltage

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Technical Specifications

where 802.11ax is supported.

Altitude Operating 0 to 10,000 ft (3,048 m) **Non-operating** 0 to 50,000 ft (15,240 m)

LED Activity

LED Amber – Radio OFF

LED Off – Radio ON

 Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for Wi-Fi 6 (802.11ax WLAN) are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries

2. Wi-Fi supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate³ 2.17 Mbps

BLE: 1 Mbps signaling data rate¹ 0.2 Mbps

3. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.



Technical Specifications

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi + BT54

Wireless LAN Standards

IEEE 802.11a

IEEE 802.11b

IEEE 802.11a IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h IEEE 802.11i

IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability

Wi-Fi® CERTIFIED modules

Frequency Band • 802.11b/q/n

2.402 - 2.482 GHz

• 802.11a/n/ac

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz 5.47 - 5.725 GHz

5.825 - 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ • IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum

• 802.11n HT20(5GHz): +15.5dBm minimum

• 802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

• Transmit mode: 2.0 W **Power Consumption**

• Receive mode: 1.6 W

• Idle mode (PSP) 180 mW (WLAN Associated)

• Idle mode: 50 mW (WLAN unassociated)

Connected Standby/Modern Standby: 10mW

· Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

Technical Specifications

802.11 compliant power saving mode

Receiver Sensitivity⁴ • 802.11b, 1Mbps: -93.5dBm maximum

> • 802.11b, 11Mbps: -84dBm maximum 802.11a/q, 6Mbps: -86dBm maximum • 802.11a/q, 54Mbps: -72dBm maximum • 802.11n, MCS07: -67dBm maximum • 802.11n, MCS15: -64dBm maximum • 802.11ac, MCS0: -84dBm maximum

High efficiency antenna with spatial diversity, mounted in the display Antenna type

• 802.11ac. MCS9: -59dBm maximum

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8 q

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Operating 14° to 158° F (-10° to 70° C) **Temperature**

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF

LED Off - Radio ON

4. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.0 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available

Channels

Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate⁵ throughput up to 2.17 Mbps

BLE: 1 Mbps signaling data rate¹ throughput up to 0.2 Mbps

5. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Technical Specifications

Intel® XMM™ 7360 LTE-Advanced* **Technology/Operating** FDD LTE:

hands | LTF: 2100 (F

LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700 (Band 4),

850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12),

700 (Band 13)

700 (Band 17), 850 (Band 18), 850 (Band 19), 800 (Band 20), 1450 (Band

21), 850 (Band 26)

700 (Band 28) MHz, 700 (Band 29), 2300 (Band 30), 2100 (Band 66) MHz

TDD LTE:

2600 (Band 38), 1900 (Band 39), 2300 (Band 40), 2500 (Band 41) MHz HSPA+: 2100 (Band 1), 1900 (Band 2), 1700 (Band 4), 850 (Band 5), 900

(Band 8) MHz

Wireless protocol

standards

otocol 3GPP Release 11 LTE Specification CAT.9, MAX 60MHz aggregation BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-B and LTO)

GPS bands GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou

1561.098 ± 2.046 MHz

Maximum data rates LTE: 450 Mbps (DL 3CA), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

Maximum powerLTE: 1,200 mA (peak); 900 mA (average)consumptionHSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions (Length x Width x Thickness)

42 x 30 x 2.3 mm



^{*} WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Technical Specifications

POWER

AC Adapter 45 Watt Smart Dimensions 95 x 45 x 26.8 mm nPFC Standard Barrel 4.5mm Right Angle 1.8m Weight 200 g +/- 10 g

Input Input Efficiency 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power 45 W

DC output 19.5 V

Hold-up time 5 ms at 115 Vac input

Output current limit <8.0A

Connector 4.5mm Barrel Type

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and SafetyCE Mark - full compliance with LVD and EMC directives
Worldwide safety standards - IEC60950, EN60950, UL6

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.



Technical Specifications

AC Adapter 45 Watt Smart Dimensions nPFC Standard Barrel 4.5mm Right Angle 1.8m 2pronq

Weight

Input

200 a +/- 10 a

Input Efficiency

95 x 45 x 26.8 mm

87.74 % at 115 Vac and 88.4 % at 230Vac

Input frequency range

47 ~ 63 Hz

Input AC current

Max. 1.4 A at 90 VAC

Output **Output power** 45 W 19.5 V

DC output Hold-up time

5 ms at 115 Vac input

Output current limit

<8.0A

Connector

4.5mm Barrel Type

Environmental Design

Operating

32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B.

FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

MTBF - over 200,000 hours at 25°C ambient condition.

Technical Specifications

AC Adapter 65 Watt Smart Dimensions (H x W x D) nPFC Standard Barrel

Weight 4.5mm Right Angle 1.8m

230g +/-10%

90 x 51 x 28.5mm

Input **Input Efficiency**

88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5 ms at 115 Vac input

Output current limit <11.0A

Connector 4.5mm Barrel Type

Environmental Design Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives Certifications

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.



Technical Specifications

AC Adapter 65 Watt Smart Dimensions (H x W x D) nPFC EM Barrel 4.5mm

New EM

Weight

250g +/-10%

102 x 55 x 30mm

Input

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

65W

Input frequency range 47 ~ 63 Hz

Input AC current

Max. 1.7 A at 90 Vac

Output

Output power

DC output 19.5V

Hold-up time 5 ms at 115 Vac input

Output current limit <11.0A

Connector

4.5mm Barrel Type

Environmental Design

Operating

32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt nPFC Dimensions (H x W x D) Standard USB Type-C® Straight 1.8m

94.0 x 40.0 x 26.5 mm

Weight

192.5g +/-10%

Input

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:87.41% 15V:87.8%

Input frequency range

47 ~ 63 Hz

Input AC current

Max. 1.4 A at 90 Vac

Output

Output power

5V/15W 9V/27W

> 12V/36W 15V/45W

DC output

5V/9V/12V/15V

Hold-up time

5 ms at 115 Vac input

Connector

USB Type-C®



Technical Specifications

Environmental Design Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions Standard USB type C® Weight Straight 1.8m

 Dimensions
 90.0 x 51 x 28.5mm

 Weight
 250 q +/- 10 q

Input Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range 47 ~ 63 Hz

Input AC current 1.6 A at 90 VAC and maximum load

Output Output power 65 W

DC output 5V/9V/12V/15V/20V **Hold-up time** 5 ms at 115 Vac input

Output current limit 8.0A Max.

Connector USB Type C®

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

Technical Specifications

Battery CC 3 Cell WHr 53 Long Life -PL Fast Charge Dimensions (H x W x L)

7.3 x 52.9 x 267.11mm (0.287 x 2.082 x 10.516 inch)

Weight

Cells/Type 3cell Lithium-Ion Polymer cell / 645180

0.205kg (0.45 lb)

Voltage 11.55V Amp-hour capacity 4.59Ah Watt-hour capacity 53Wh

Temperature 32° to 113° F (0° to 45° C)

Operating (Charging) 32° to 122° F (0° to 50° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C)

Warranty Depends on system offering

Optional Travel Battery

Available

No

Battery GR 3 Cell WHr 42 Long Life -PL Fast Charge Dimensions (H x W x L)

5.8 x 61.5 x274.4 mm (0.228 x 2.42 x 10.80 inch)

Weight

0.168 kg (0.37 lb)

Cells/Type

3cell Lithium-Ion Polymer cell / 485083

Energy

Voltage 11.4V Amp-hour capacity 3.64Ah Watt-hour capacity 42Wh

Temperature

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Warranty: Depends on system offering

Fuel Gauge LED NA

Country of Origin

China

Technical Specifications

FINGERPRINT READER

Model Synaptics Validity VFS7604 touch sensor

9.6MHz

Mobile Voltage Operation3.0 V to 3.6 VOperating Temperature: $0 \sim 60 ^{\circ} \text{C}$ Current Consumption Image:100 mA MaxLow Latency Wait For Finger260 uA

Capture Rate: Image transmitter output frequency

ESD Resistance IEC 61000-4-2 4B (+/-15KV) **Detection Matrix** 363 dpi / 7.4x6mm sensor area

FRR (False Reject Rate) / FAR (False Acceptance Rate) FRR <1% @ 1:50K FAR



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
	HP Business Backpack (17.3")	2SC67AA
	HP Business Case (15.6")	2SC66AA
	HP Business Slim Top Load (14.1")	2SC65AA
	HP 14.1 Business Sleeve	2UW01AA
	HP 13.3 Business Sleeve	2UW00AA
Docking	HP USB-C Mini Dock	1PM64AA
	HP Thunderbolt Dock 120W G2	2UK37AA
	HP TB Dock G2 w/ Combo Cable	3TR87AA
	HP TB Dock 120W G2 w/Audio	3YE87AA
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	3AQ21AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP USB-C Dock G5	5TW10AA
Input/Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Bluetooth Travel Mouse	6SP30AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
	HP Elite USB-C Hub	4WX89AA
	HP USB-C Travel Hub G2	7PJ38AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA#xxx
	HP 45W Smart Power Adapter 2 prong -4.5mm (Japan only)	L6F60AA#ABJ
	HP 65W Smart Power Adapter (w/ 4.5mm to 7.5mm DC dongle)	H6Y89AA
	HP 65W Slim AC Adapter	H6Y82AA#xxx
	HP 65W USB-C Slim Power Adapter	3PN48AA#xxx
	HP 65W USB-C Power Adapter	1HE08AA#xxx
	HP 45W USB-C Power Adapter	1HE07AA#xxx
	HP Power Bank	N9F71AA#xxx
Storage	HP External USB Optical Drive	F2B56AA
-	HP 1TB TLC PCIe 3x4 NVMe M.2 Solid State Drive	6SK99AA
	HP 2TB TLC PCIe 3x4 NVMe M.2 Solid State Drive	6SL00AA



HP ProBook 635 Aero G7 Notebook PC

QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

Security HP Sure Key Cable Lock 6UW42AA

HP Nano Keyed Cable Lock 1AJ39AA

UCC HP UC Speaker Phone 4VW02AA



Summary of Changes

Date of change:	Version History:	Description of change:
October 13, 2020	V1 to V2	Overview, At a glance and Port sections updated
October 29, 2020	V2 to V3	At a glance, Power, Dimensions section updated

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